

Information for Lot 9 of ErP (Ecodesign)

This addendum addresses European Union (EU) Ecodesign requirements for servers and storage products. All data and ratings within this addendum are in reference only to the Supermicro product(s) in the manual. The below information conforms to requirements laid down in Annex II of the Commission Regulation 2019/424.

- 3(1)(a): See Section 1.1 of the system manual for the product type.
- 3(1)(b): See the title page and preface of the system manual for the trademark and manufacturer's address.
- 3(1)(c): See the title page of the system manual for product model number(s).
- 3(1)(d): See the serial number on the physical system to determine the year of manufacture.
- 3(1)(e-j): **PSU Efficiency and Power Factor Value (Table) (From 80 Plus report)**

PSU Model #: PWS-1K69A-1R Watts: 1600	PSU efficiency				power factor
% of rated load	10 %	20 %	50 %	100 %	50 %
Single output (AC-DC)	91.0 %	93.9 %	94.6 %	92.7%	0.99

System (EUT) Efficiency in **Idle State Power** (Table)

Representative Configurations	Measured Idle State Power (W)	Calculated Idle Power Allowance (W)
High-end performance configuration	306.00	453.96
Typical Configuration	N/A	N/A
Low-end performance configuration	291.40	311.78

System (EUT) Efficiency in **Active State Power** (Table)

Representative Configurations	Active state efficiency score (Eff _{server})	Minimum active state efficiency for 2 socket server
High-end performance configuration	22.8	9.5
Typical Configuration	N/A	
Low-end performance configuration	12.3	

3(1)(k): The operating condition class is **A2**.

Operating condition class	Dry bulb temp °C		Humidity range, non-condensing		Max dew point (°C)	Maximum rate of change (°C/hr)
	Allowable range	Recommended range	Allowable range	Recommended range		
A1	15- 32	18-27	- 12 °C Dew Point (DP) and 8 % relative humidity (RH) to 17 °C DP and 80 % RH	- 9 °C DP to 15 °C DP and 60 % RH	17	5/20
A2	10-35	18-27	- 12 °C DP and 8 % RH to 21 °C DP and 80 % RH	Same as A1	21	5/20
A3	5-40	18-27	- 12 °C DP and 8 % RH to 24 °C DP and 85 % RH	Same as A1	24	5/20
A4	5-45	18-27	- 12 °C DP and 8 % RH to 24 °C DP and 90 % RH	Same as A1	24	5/20

3(1)(l): The idle state power at the higher boundary temperature of the operating conditions class is 361 W.

3(1)(m): The active state efficiency and performance is SERT Score = 22.8 (High End Configuration)

3(1)(n): There are two methods by which a user can securely delete data from this system. The user performing secure data deletion should be an IT professional.

The first is with a Unified Extensible Firmware Interface (UEFI) shell utility. This utility works on X10/X11/H11/H12/M11 motherboard series with onboard SATA/NVMe devices. Any user may access and download this utility through following link: https://www.supermicro.com/about/policies/disclaimer.cfm?url=/wftp/utility/Lot9_Secure_Data_Deletion_UTILITY/

Download the shell utility package and extract it to a USB flash drive, then plug the drive into the server for which secure data deletion is necessary. Then turn the system on. Navigate to the BIOS setup menu, then place the server system into the UEFI shell environment. Follow the instructions in the README file to invoke the utility and complete the deletion.

The second method is through the secure data deletion tool provided by the original manufacturer of the hard drive. This should be used in a scenario where the shell utility is not applicable. Each manufacturer should have the tool available on their website. If needed, please look on the hard drive label for the name of the manufacturer and model information.

3(1)(o): List of recommended combinations of blade servers with chassis: N/A.

3(1)(p): List of all current SKUs within this product family: SSG-1029P-NEL32R.

3(3)(a): There is no use of cobalt in batteries in this product.

The indicative weight range of neodymium in the HDD is 0.0 if manufactured by Western Digital, and is between 5-25 grams if manufactured by Seagate.

3(3)(b): Please see the disassembly instructions on the next page.

Illustrated System Disassembly Instructions

Please note: All the illustrations in the below disassembly instructions are for demonstration only. Components shown here may not match exactly with the components in your system.

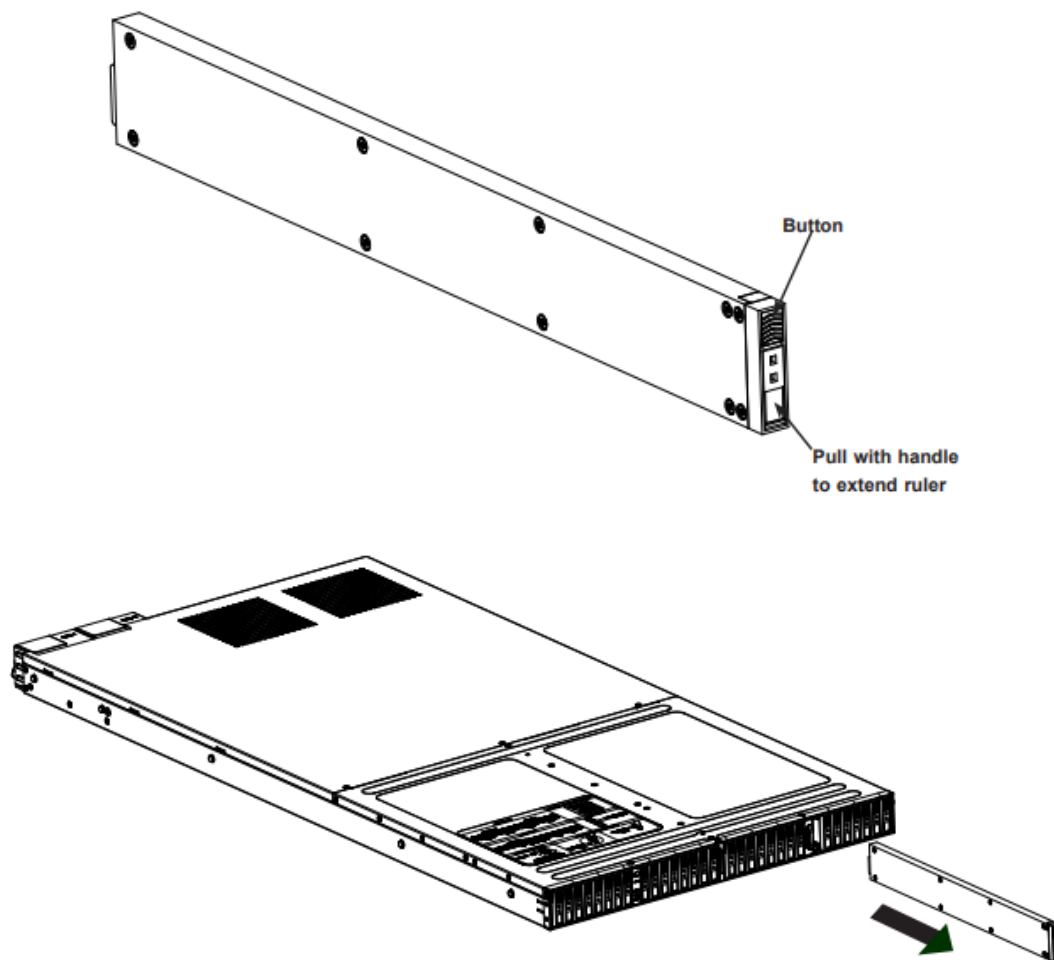
CAUTION: Always power off the system and unplug the power cord(s) first before disassembling the system!

1. Data Storage Devices

Type and number of fastenings: None.

Tools required: None.

Procedure: Push the release button on the carrier upward to release the handle. Grasp the handle and pull the drive out of its bay.

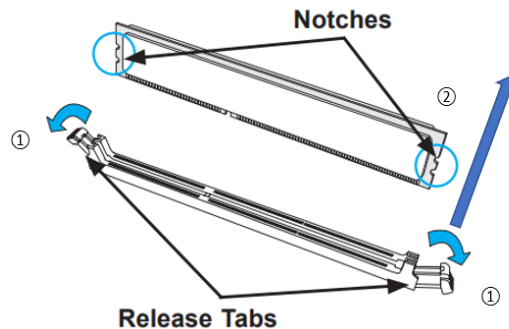


2. Memory

Type and number of fastenings: Two (2) latches per memory module.

Tools required: None.

Procedure: Press both release tabs on the ends of the memory module to unlock it. Once the module is loosened, remove it from the memory slot.

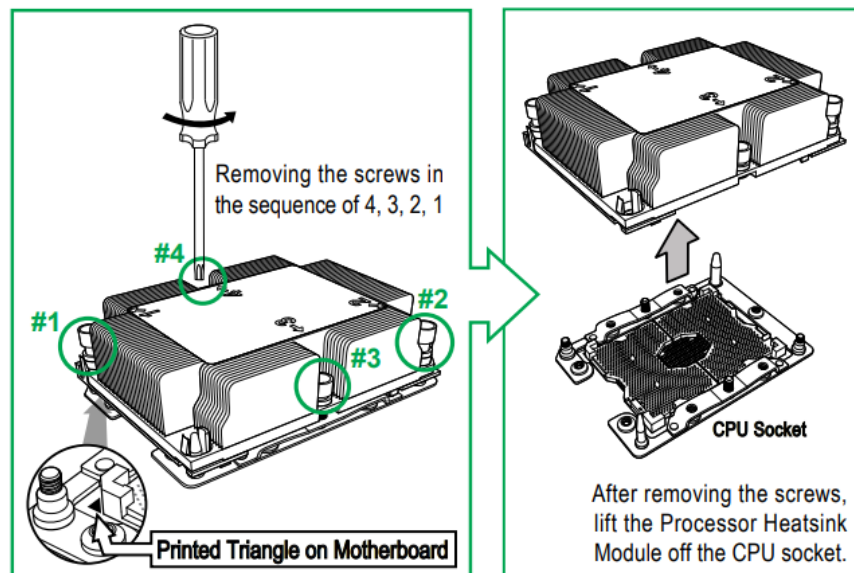


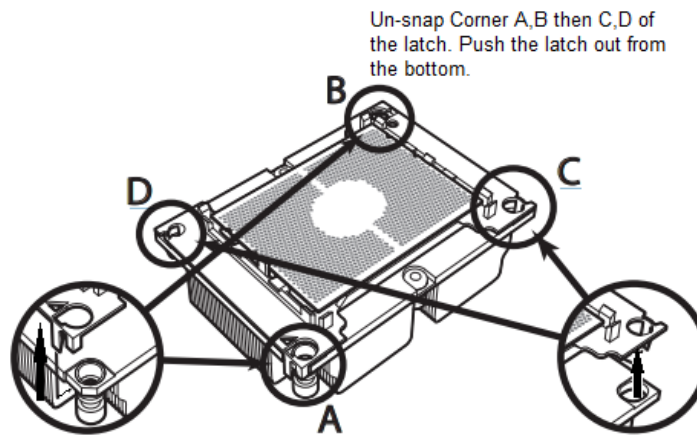
3. Processor

Type and number of fastenings: Four (4) T30 Torx screws.

Tools required: Screwdriver with T30 Torx bit.

Procedure: Remove the screws in the sequence of 4, then 3, then 2, then 1, as marked in the illustration below. After removing the screws, lift the processor heatsink module off the processor socket. Unsnap corners A and B, then C and D of the latch. Push the latch out from the bottom.



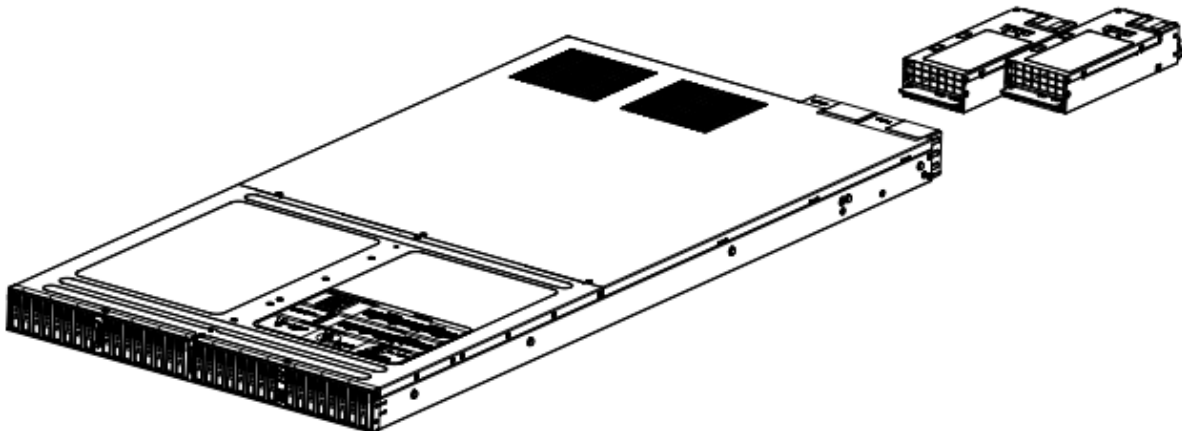


4. Power Supply Module

Type and number of fastenings: One (1) latch per module.

Tools required: None.

Procedure: Unplug the power cord from the power supply. Push the release tab on the back of the power supply module to the side and pull the module straight out.

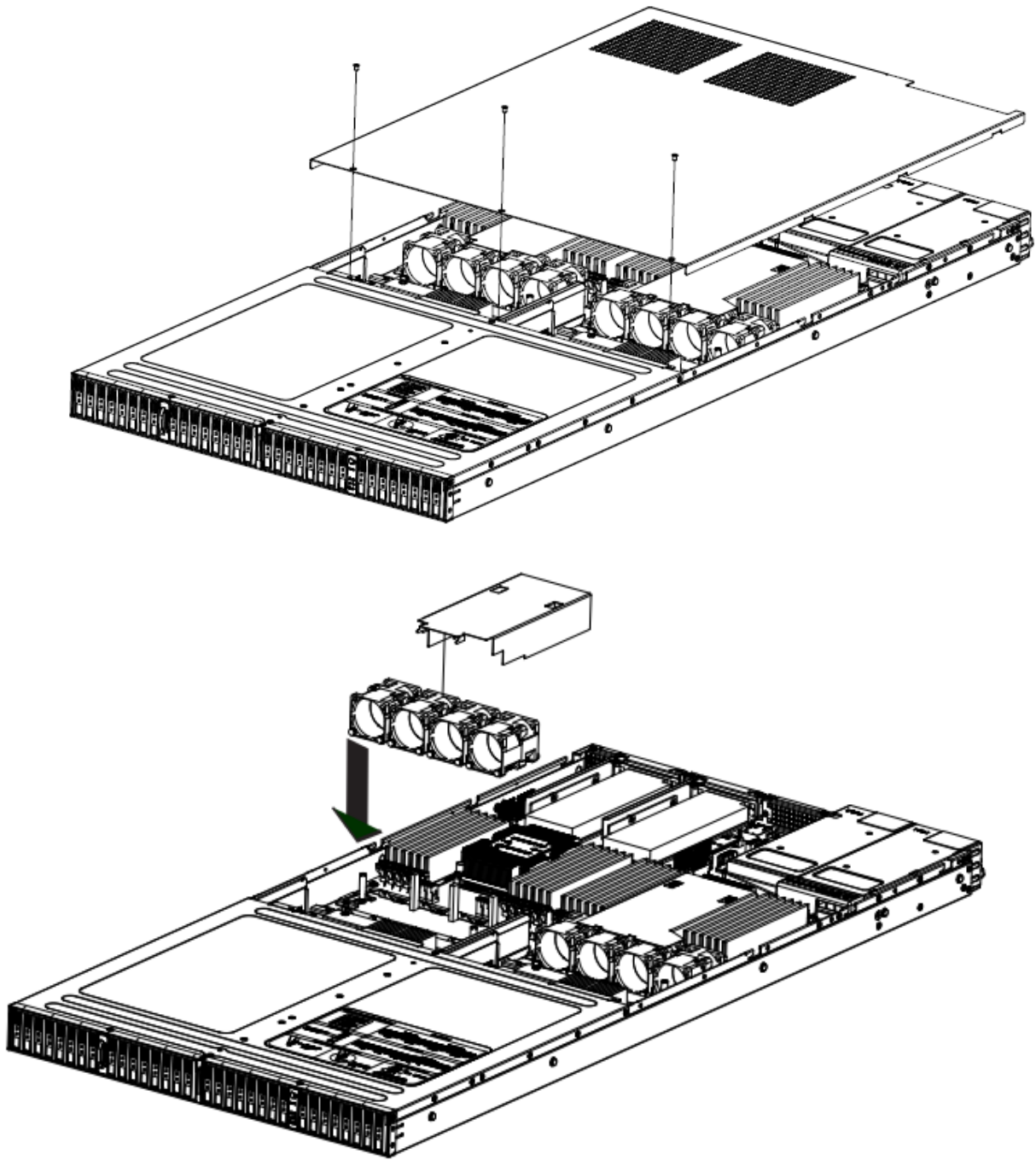


5. Fans

Type and number of fastenings: One (1) latch per fan.

Tools required: None.

Procedure: Simultaneously press down on the upper release tab while pushing up the lower release tab. Pull the fan out of the rear of the chassis.



6. Motherboard

Type and number of fastenings: Eight (8) fan housings and power supply shroud to expose the motherboard, two PCIe umbilical cords, and two PCIe brackets. 12 Phillips screws to remove the motherboard.

Tools required: Screwdriver with PH2 bit.

Procedure: (Fig. 1). Remove the eight fan modules, two CPUs, and two PCIe umbilical cords (Fig. 2). Remove each PCI bracket by unscrewing the two screws holding it in place. (Fig. 3). The motherboard is now exposed. To remove it, unscrew the 12 Phillips screws, detach the power supply shroud, and lift the motherboard from its base.

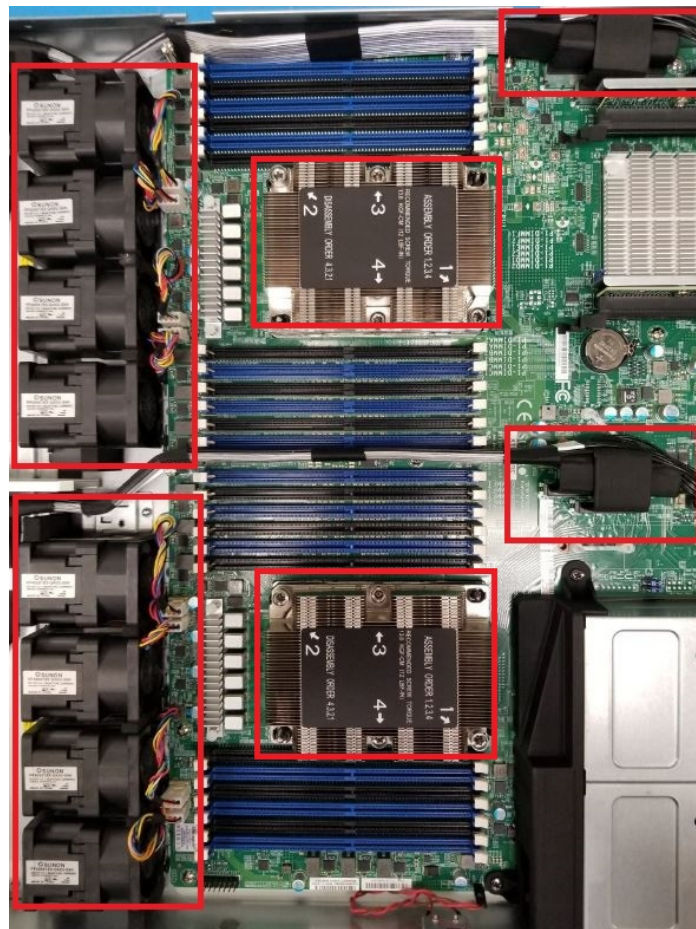


Fig. 1

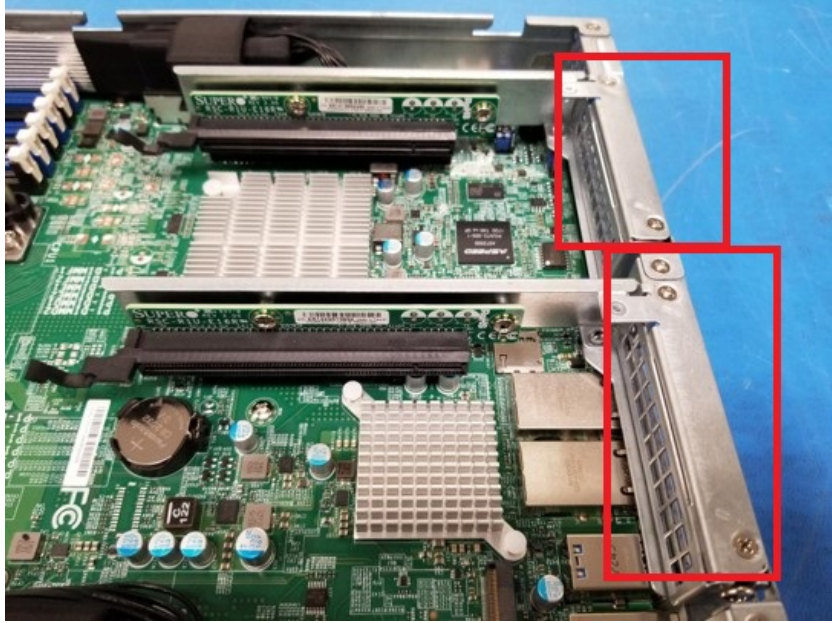


Fig. 2

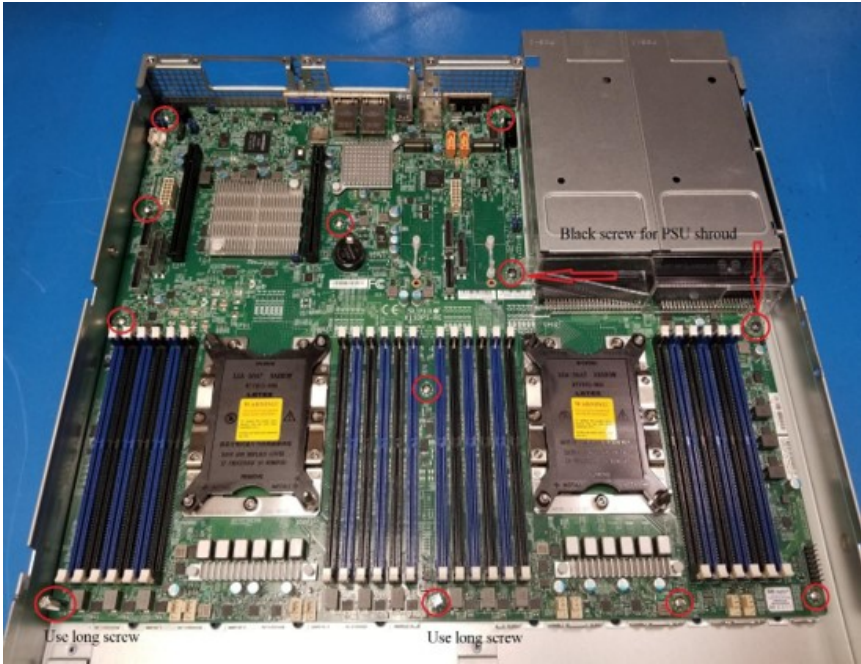


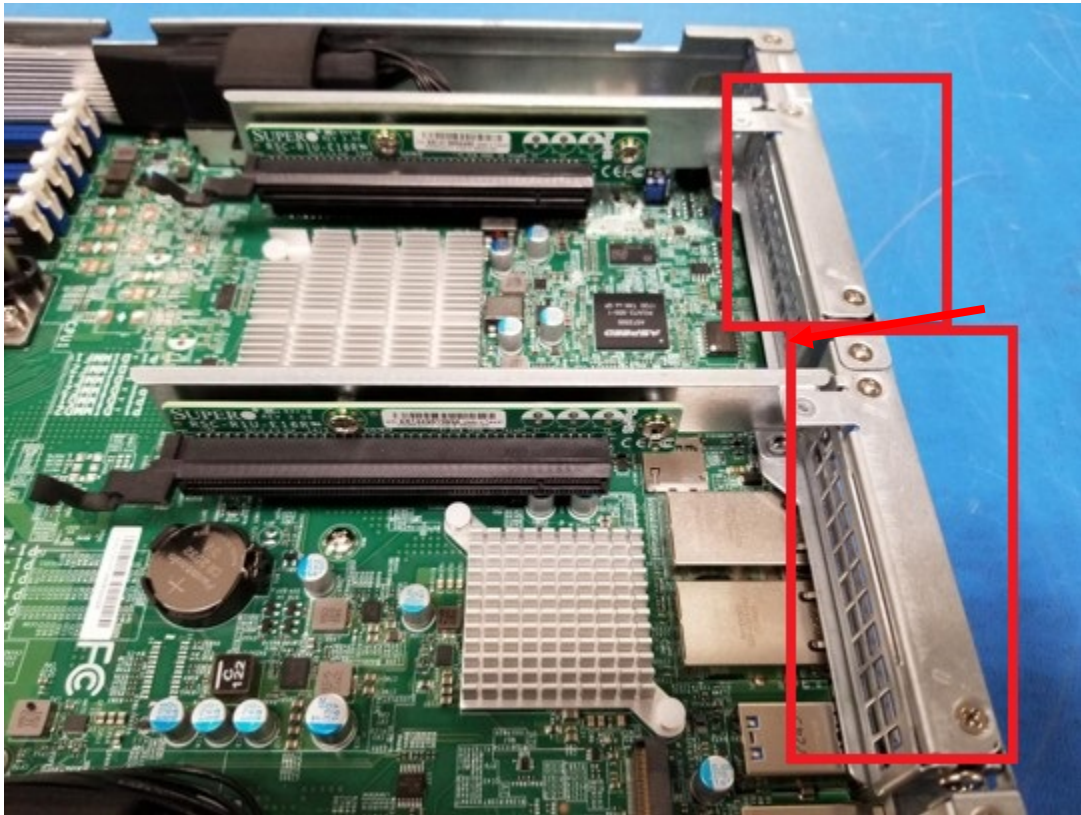
Fig. 3

7. Expansion Card

Type and number of fastenings: Two (2) Phillips screws.

Tools required: Screwdriver with PH2 bit.

Procedure: Remove the Phillips screws on each PCIe bracket, then pull upward to remove the expansion card from the PCIe slot.

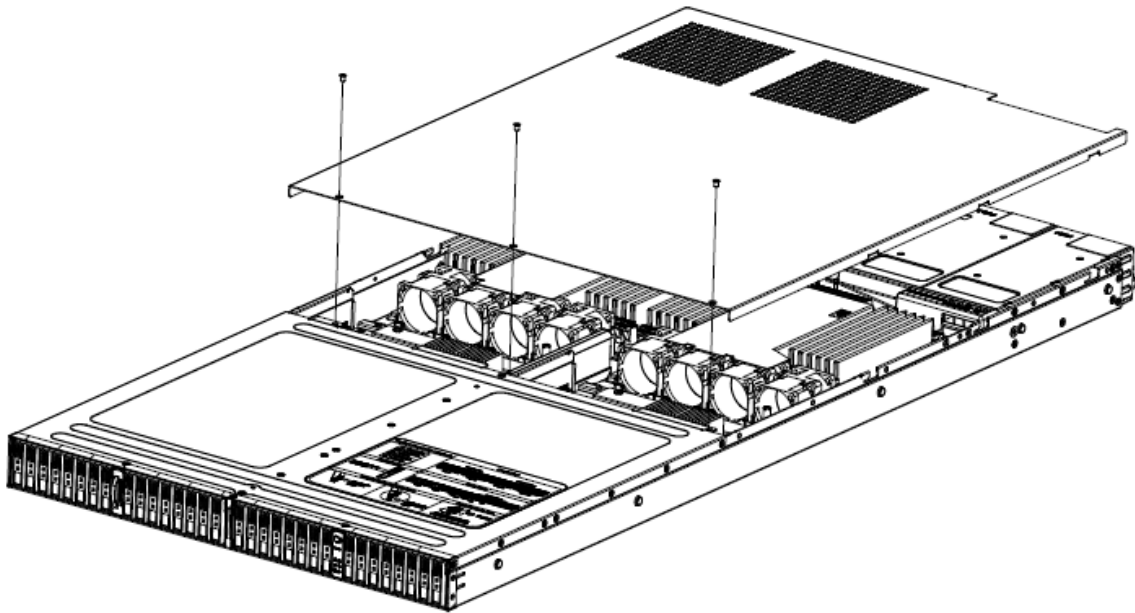


8. Chassis Cover

Type and number of fastenings: Three (3) Phillips screws.

Tools required: Screwdriver with PH2 bit.

Procedure: Unscrew the three Phillips screws, then pull the cover back and lift the cover from the chassis.



9. Batteries

Type and number of fastenings: One (1) latch.

Tools required: None.

Procedure: Push aside the small clamp that covers the edge of the battery. When the battery is released, lift it out of the holder.

